



Simulation study of MPGD technique for CMS inner muon detector upgrade

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Outline

Introduction

- The CMS Muon System
- The CMS GE1/1,GE2/1 and ME0 Upgrade
- The GEM,FTM and µRWELL technique
- Finite element analysis
 - Multi-layer FTM
 - Triple-GEM
 - micro-Resistive WELL

Simulation & reconstruction

- Field, gas
- Heed and avalanche(geant4)
- Signal readout and storage
- Data analysis
 - Time resolution
 - spatial resolution

Summary and Outlook





GE1/1 upgrade



GE1/1 assembly and test procedures



- Analog electronics
- LHC delivered ~ 45 fb⁻¹
 Total area : 3 × 10⁴ cm²

- . Will be installed in LS2 (2018-2019)
 - GEM chambers will be assembled and tested in 6 production sites
- . 8 QC procedure were defined for GEM assembly and test
 - China will provide front end board GEB (GEM Electronics Board)
 - 10 GE1/1 slice test detectors installed in January 2017
 - Chambers in operation since May 2017
 - HV on in Ar/CO2 70:30
 - Gas gain ~ 1 × 10⁴
 - 2 chambers with HV supplied individually to each of 7 electrodes
 - 8 chambers with HV supplied through HV divider



ME0 upgrade

 Extend muon tagging coverage up to η~2.9 and enhance trigger to η~2.4 range using space available in the back of the new endcap calorimeter

Mechanical

Guiding Rail & Services Pocket

20 degree Chamber

 $\Delta x = 30 \text{ cm}$

or package of 6

Muon track

 $\Delta \phi$

• MEO baseline is 6 layers of triple-GEMs arranged in 20^o super-module wedges.

High granularity spatial segmentation for:

 Position and bending measurement of the muon stubs for efficient matching of offline pixel tracks.

Multi-layered structure to:

- improve local muon track reconstruction
- discriminate muon (segment) against neutrons (uncorr hits).

Option: precision timing

 Option for Fast Timing Micro-pattern (FTM) detector to reject background hits from pile-up and neutron background – small prototype under study (Maggi, De Oliveira, Sharma <u>arXiv:1503.05330v1</u>)

GE2/1 upgrade

Baseline: GEM

ME2/1 CSC

Shiel

1837 mm

Reinforcement elements

The station GE2/1 consists of 72 triple-GEM chambers arranged in 36 20⁰ Super-chambers, covering $1.60 < |\eta| < 2.46$.

Layout is similar to GE1/1, but covering much larger surface: ✓ Will be the largest triple-GEM chambers built

Optimization of engineering design for mass production on-going



GE2/1

- only 81 mm clearance including services
- four foil modules structure per 20degree chamber, 6 φ-sectors × 8 ηsectors total
- Option for μ-R-Well technology as compact and low cost large detector (G. Bencivenni et al., 2015_JINST_10_P02008)





3 MPDG (Micro-Pattern-Gaseous-Detectors) techniques:

GEM





Amplifier

Induction

GEM 3 ==

Readout PCB



μ-RWELL

0



Readout



Simulation process

Gas and field preparation



Magboltz : gas property calculation

Ansys : electric field, material property, etc



Garfield++



Preliminary ionization

Heed(Garfield++) or Geant4





Time resolution, spatial resolution, etc.

An additional electric field to calculate the induced signal

Weighting field

readout

avalanche

Give every electron a avalanche from a position, direction, energy

Finite element analysis: GEM

Triple-GEM

Drift: -4000V G1UP: -3060V G1DOWN:-2580V G2UP: -2205V G2DOWN:-1735V G3UP: -985V G3DOWN:-535V READOUT: 0V

Gas: Ar:CO2=70:30 Temperature: 20°C Drift filed :3kV/cm



Finite element analysis: FTM



Finite element analysis: µ RWell









Weighting field readout

Ramo's Theorem :

set the voltage of readout board to 1 and the other electrodes to 0, electrons drift in this weighting field and induce signal on the readout board.





Effect of resistive electrode:





µRWell: the effect of resistive electrode is ignored



FTM: the screening effect of resistive electrode is considered: no weighting electric field



µRWell: the screening effect of resistive electrode is considered: no weighting electric field

GEM Reconstruction



FTM Reconstruction

- Particle: π , μ -
- Energy :150GeV
- Direction : downstream
- Initial position(cm): (0.02) , in the center of the model
- RC: 30ns,50ns
- Particle Time interval : 500ns

µRWELL Reconstruction

- Particle: π , μ -
- Energy :150GeV
- Direction : downstream
- Initial position(cm): (0.0775), in the center of the model
- RC: 30ns , 50ns
- Particle Time interval : 500ns



Data analysis

- Time resolution : Constant Fraction Timing
- Position resolution : The center-of-gravity method



$$X_0 = \frac{\sum_{i=1}^n X_i Q_i}{\sum_{i=1}^n Q_i}$$

 X_i : Center position of the *i*-th strip,

*Q*_i : Charge of the signal in *i*-th strip,

 X_0 : position of the signal after center of gravity method.

Results: Triple-GEM

Particle: µ-

Energy: 150GeV

RC= 50ns

Gas: Ar/Co2/CF4=45/15/40





Results: FTM



No doubt, efficiency is higher with more gas gaps.

FTM Result: time resolution at different incident particle and forming time, relative to the drift electric field



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FTM Result: time resolution at different incident particle and gas composition, relative to the number of layers



For different particles, time resolution does not change too much; Gas mixture with CF4 makes the resolution better.

FTM Result: compare with beam test



µRWell Results from different forming time



1.1.1

µRWell Result from different gas composition



Gas mixture without CF4 makes both time and spatial resolution worse !

µRWell Result from different incident particles



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µRWell Result: compare with beam test



Match quite well with each other !

Summary and Outlook

- We have carried out simulation study of different MPGD techniques for CMS muon detector upgrade, including triple-GEM,FTM and µRWell techniques.
- For each type of MPGD techniques, the simulation results are consistent with the experimental beam test results, in terms of time and space resolutions etc.
- Still some differences between MC and experimental results need to be studied and understood.
- More studies can been performed to understand how the working condition (detector structure, gas composition, number of layers, HV, forming time etc.) affect the performance of the detector, which will give references to the choice of the detector technique and the design of the detector.

Thank you !